

Title (en)
ASSEMBLY FOR SETTING THE POSITION OF BOARDS ON THE FACE OF A WALL AND SYSTEM FOR INSTALLING BOARDS ON THE FACE OF A WALL

Title (de)
TEILESATZ ZUM FESTLEGEN DER POSITION VON PLATTEN AUF DER OBERFLÄCHE EINER WAND UND SYSTEM ZUM INSTALLIEREN VON PLATTEN AUF DER OBERFLÄCHE EINER WAND

Title (fr)
JEU DE PIÈCES POUR FIXER LA POSITION DE PLAQUES SUR LA SURFACE D'UN MUR ET SYSTÈME POUR INSTALLER DES PLAQUES SUR LA SURFACE D'UN MUR

Publication
EP 3907350 C0 20230830 (EN)

Application
EP 21172357 A 20210505

Priority
PL 43389420 A 20200506

Abstract (en)
[origin: EP3907350A1] The subject matter of the invention is an assembly for setting the position of boards - positioning as well as a complete system for installing large-format boards on the underlying surface, i.e., fixing and positioning, relying on a chemical mixture for correct fixing of large-format boards together with the use of the positioning assembly. For the most part, the invention is an assembly for positioning large-format boards on a face surface, which system is characterized in that it comprises a mean for fixing-and-separating - element for positioning a board on the face surface and setting the gap to an adjacent board, as well as a face wedge that is mounted to the fixing-and-separating element to enable adjacent boards to be evenly laid - placed on the wall in relation to each other at distance set by the thickness of the relevant part of the fixing-and-separating element. The fixing-and-separating element and the face wedge are mutually shaped so that the setting face wedge hitches to the catch that is formed on the fixing-and-separating element, so that the face wedge presses the adjacent boards against the face surface after they have been put in place. Formed on the fixing-and-separating element there is a base that is a springy foot - spring stand, which gets placed under the board being installed, and from which foot there extends a grip at an angle of 90° whose thickness is adapted to the intended spacing between the adjacent boards.

IPC 8 full level
E04F 21/00 (2006.01); **E04F 21/18** (2006.01); **E04F 21/22** (2006.01)

CPC (source: EP)
E04F 21/0092 (2013.01); **E04F 21/1877** (2013.01); **E04F 21/22** (2013.01)

Designated contracting state (EPC)
AL AT BE BG CH CY CZ DE DK EE ES FI FR GB GR HR HU IE IS IT LI LT LU LV MC MK MT NL NO PL PT RO RS SE SI SK SM TR

Participating member state (EPC – UP)
AT BE BG DE DK EE FI FR IT LT LU LV MT NL PT SE SI

DOCDB simple family (publication)
EP 3907350 A1 20211110; **EP 3907350 B1 20230830**; **EP 3907350 C0 20230830**; ES 2957161 T3 20240112; PL 3907350 T3 20240408; PL 433894 A1 20210308; WO 2021225460 A1 20211111

DOCDB simple family (application)
EP 21172357 A 20210505; ES 21172357 T 20210505; PL 2021050031 W 20210505; PL 21172357 T 20210505; PL 43389420 A 20200506